



Product Change Notification

Change Notification #: 116996 - 00
Change Title: Intel® Server System R1208WFTYSR, PCN 116996-00, Label, 1100W Power Supply: Add URL to BIS mark
Date of Publication: June 14, 2019

Key Characteristics of the Change:

Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: *	July 1, 2019
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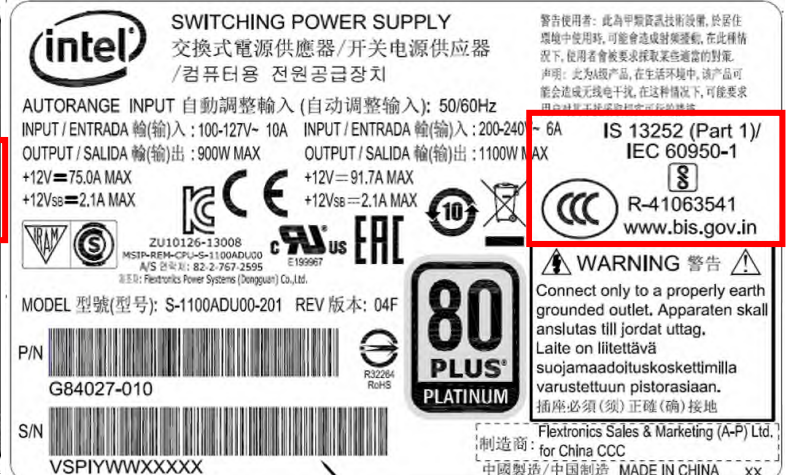
*Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel

Description of Change to the Customer:

Intel is updating the label of the 1100 power supply included in the Intel® Server System R1208WFTYSR. The new label includes a URL of the BIS mark and remove "S&E" inside the CCC logo.

Image 1. Power supply label before change

Image 2. Power supply label after change



Customer Impact of Change and Recommended Action:

Intel does not expect any other impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications. For that reason Intel recommends that the customer perform a standard level of evaluation. Customers can download and evaluate the latest BIOS/ME/Integrated BMC and FRUSDR release notes for more information at <http://www.intel.com/support>.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
R1208WFTYSR	986007	K39975-003	K39975-004

PCN Revision History:

Date of Revision:

June 14, 2019

Revision Number:

00

Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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